

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3903563

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LINGXIAO DU	05/30/2016
KANG YANG	05/30/2016
HONG DING	05/30/2016
GUJUN LI	05/30/2016
SHAOFAN LIU	05/30/2016

RECEIVING PARTY DATA

Name:	SHANGHAI TIANMA MICRO-ELECTRONICS CO., LTD.
Street Address:	889, HUIQING ROAD, PUDONG NEW DISTRICT
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	201201
Name:	TIANMA MICRO-ELECTRONICS CO., LTD.
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State/Country:	CHINA
Postal Code:	518052

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15173960

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	EMILY TITUS
SIGNATURE:	/Emily Titus/
DATE SIGNED:	06/06/2016
Total Attachments: 2 source=1011900_ASSGNMT#page1.tif source=1011900_ASSGNMT#page2.tif	

ASSIGNMENT OF NON-PROVISIONAL PATENT APPLICATION

WHEREAS, Lingxiao DU, residing at 889 Huiqing Rd., Pudong New District, Shanghai, China, Kang YANG, residing at 889 Huiqing Rd., Pudong New District, Shanghai, China, Hong DING, residing at 889 Huiqing Rd., Pudong New District, Shanghai, China, Gujun LI, residing at 889 Huiqing Rd., Pudong New District, Shanghai, China, and Shaofan LIU, residing at 6999 West Xiangnan Rd, Xiangnan District, Xiamen, China, hereinafter referred to as "Assignors," are the inventors of the invention described and set forth in the below-identified non-provisional patent application:

Title of Invention: ARRAY SUBSTRATE AND DISPLAY PANEL
Application No.: 15/173,960
Filing Date: June 6, 2016

WHEREAS, Shanghai Tianma Micro-Electronics Co., Ltd., located 889 Huiqing Rd., Pudong New District, Shanghai, China, and Tianma Micro-Electronics Co., Ltd., located 22/F, Hangdu Building, Shennan Road, Futian, District, Shenzhen, China, hereinafter referred to as "ASSIGNEE," are desirous of acquiring an interest in the invention and application and in any U.S. Letters Patent and Registrations which may be granted on any patent application claiming priority from the same;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have assigned, and by these presents do assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letter Patent and Registrations which may hereafter be granted on any patent application claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor has this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignors further agree that they will, without charge to Assignee, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent Applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including applications and instruments of transfer, and (c) perform such other acts as the Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignors have signed their names on the dates indicated.

Dated: 2016-5-30

杜凌霄
Lingxiao DU

Dated: 2016-5-30

杨健
Kang YANG

Dated: 2016.5.30

丁洪

Hong DING

Dated: 2016.5.30

李谷俊

Gujun LI

Dated: 2016.5.30

刘少凡

Shaofan LIU